

H5N5007P

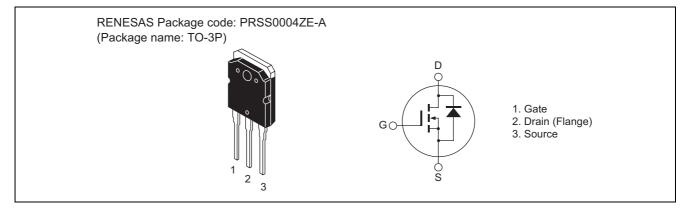
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1116-0400 (Previous: ADE-208-1404B) Rev.4.00 Sep 07, 2005

Features

- Low on-resistance
- Low leakage current
- High speed switching
- Low gate charge

Outline





Absolute Maximum Ratings

			(Ta = 25°C)
Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	500	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	ID	25	А
Drain peak current	I _{D (pulse)} Note 1	100	А
Body-drain diode reverse drain current	I _{DR}	25	А
Avalanche current	AP Note 3	7	А
Channel dissipation	Pch Note 2	150	W
Channel to case thermal Impedance	θ ch-c	0.833	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $Tc = 25^{\circ}C$

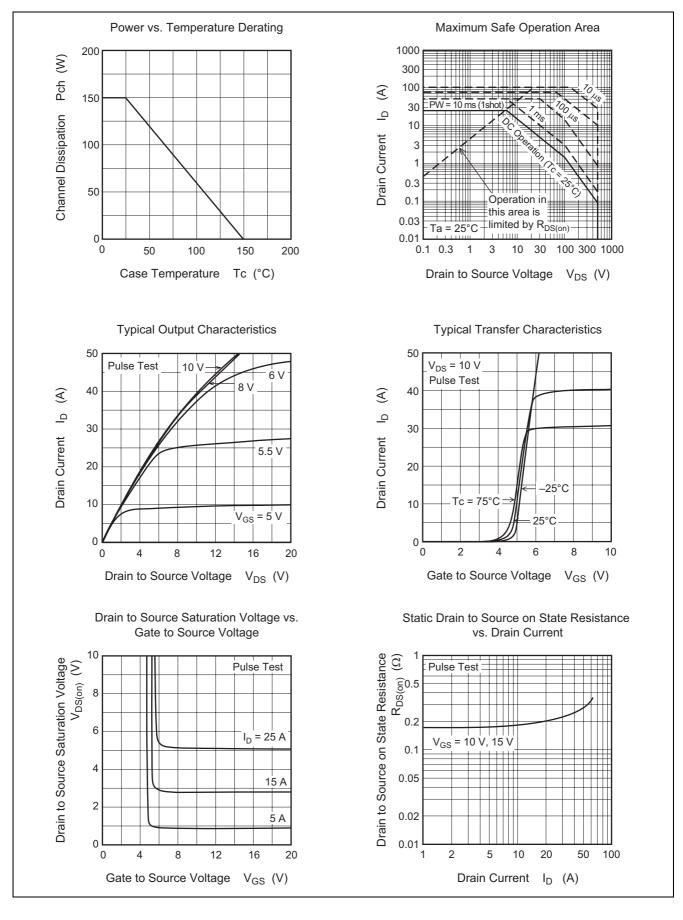
3. Tch ≤ 150°C

Electrical Characteristics

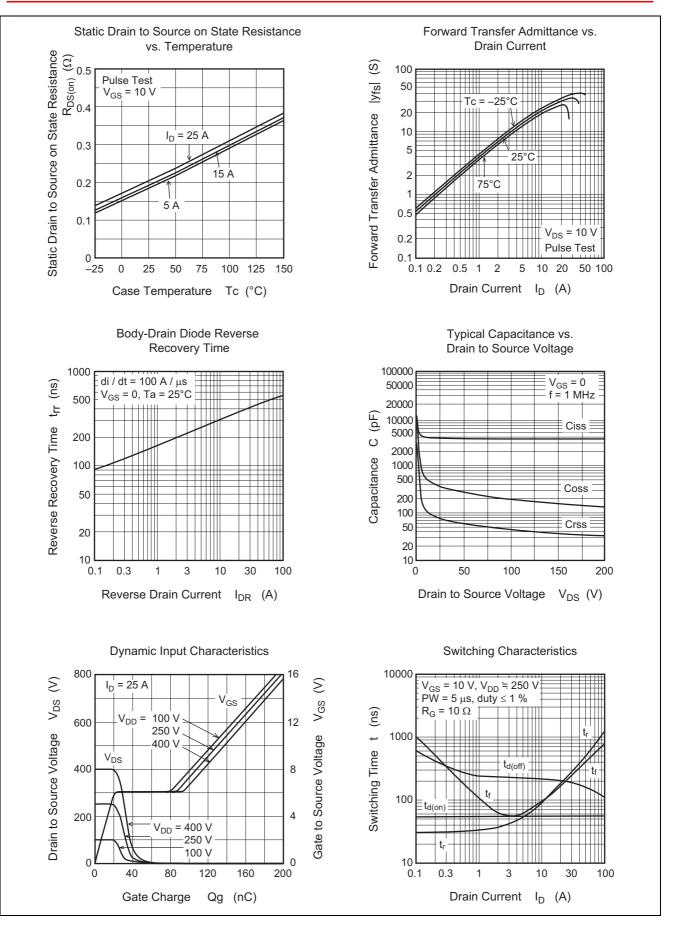
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	500	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	—	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	1	μΑ	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	3.0	—	4.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	R _{DS (on)}	_	0.18	0.225	Ω	$I_D = 12.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note 4}$
Forward transfer admittance	y _{fs}	14	24	—	S	$I_D = 12.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note 4}$
Input capacitance	Ciss	_	3900	—	pF	V _{DS} = 25 V
Output capacitance	Coss	_	375		pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	78		pF	f = 1 MHz
Turn-on delay time	t _{d (on)}	_	55		ns	I _D = 12.5 A
Rise time	tr	_	110		ns	V _{GS} = 10 V
Turn-off delay time	t _{d (off)}	_	225	—	ns	$R_L = 20 \Omega$
Fall time	t _f	_	110		ns	Rg = 10 Ω
Total gate charge	Qg	_	135		nC	V _{DD} = 400 V
Gate to source charge	Qgs	_	22		nC	V _{GS} = 10 V
Gate to drain charge	Qgd	_	74		nC	I _D = 25 A
Body-drain diode forward voltage	V _{DF}		0.9	1.4	V	I _F = 25 A, V _{GS} = 0
Body-drain diode reverse recovery time	t _{rr}		390		ns	I _F = 25 A, V _{GS} = 0
Body-drain diode reverse recovery charge	Q _{rr}	_	5	_	μC	di _F /dt = 100 A/µs

Note: 4. Pulse test

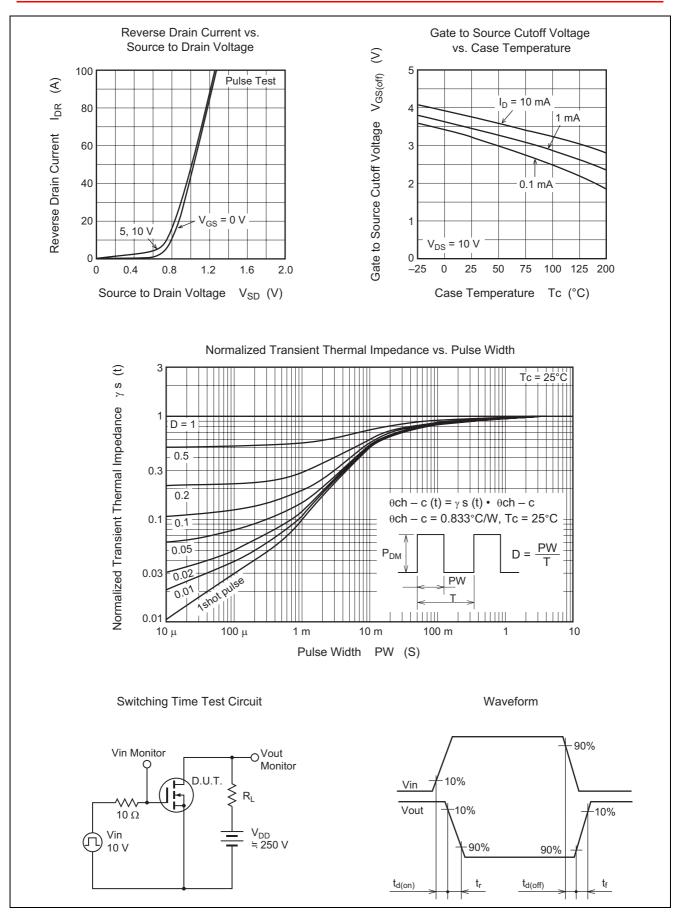
Main Characteristics



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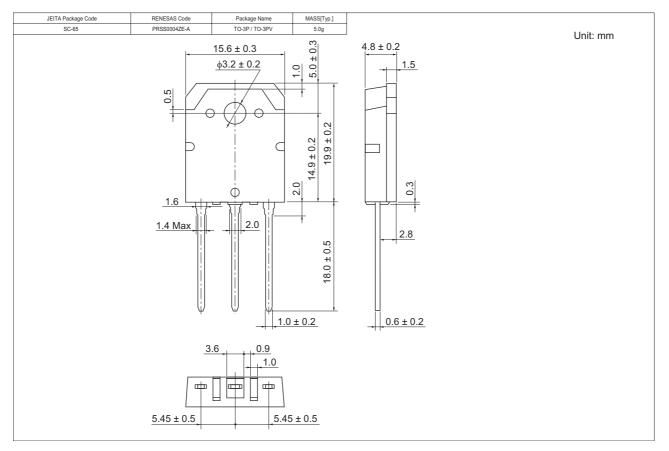






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Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
H5N5007P-E	360 pcs	Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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